# ARC3C0845/ARC3C0845W

## **Document Category: Product Brief**

## High-Efficiency LED Backlight Driver

# Semi A Murata Company

## **General Description**

The ARC3C0845/ARC3C0845W is an ultra-high efficiency DC-DC converter solution with integrated programmable current sinks that drive up to eight strings of LEDs. The ARC3C0845/ARC3C0845W integrates all MOSFETs and their control and driver circuitry. With its proprietary architecture, the ARC3C0845/ARC3C0845W provides the highest efficiency—up to 96%—possible in a compact 3.44 mm x 2.415 mm WLCSP 40-pin package (ARC3C0845W) or 4 mm x 4 mm 32-pin QFN package (ARC3C0845). The high switching frequency enables a small and low-profile solution size aligned to the needs of the latest mobile products.

## **Features**

- Synchronous DC-DC converter with integrated FETs
- 2- and 3-cell Li-ion battery input voltage for LED boost: 4.5V to 15V
- Proprietary architecture for ultra-high LED efficiency, above 88% over the operating range
- Integrated output disconnect switch
- Up to 45V output for maximum flexibility in assignment of LEDs to strings and selection of LED forward voltage
- Up to 12-bit dimming resolution with an additional 3-bit dithering
- Linear/logarithmic analog and PWM dimming for maximum flexibility and resolution
- LED brightness ramp up/down control with programmable ramp rate and linear/logarithmic ramp profiles
- Phase-shifted PWM dimming among active strings to minimize audible noise
- 1 MHz I<sup>2</sup>C 6.0-compatible serial interface to program the brightness, or an external resistor on ISET pin to set the maximum brightness
- Extensive programming capability with nonvolatile memory for storing user register settings
- Eight independently enabled current sinks, up to 43 mA per current sink
- External PWM input for fine dimming resolution
- 0.5% current matching at 30 mA per current sink
- Wide range of input and output voltages with 2x charge pump ratio

- Selectable boost switching frequency from 320 kHz to 2.6 MHz
- Extensive fault protection, including boost overcurrent protection, output short circuit protection, output over-voltage protection, LED open and short protection, and thermal shutdown

## **Applications**

Typical applications for 2- and 3-cell platforms include the following:

- 8"-17" FHD/UHD + LCD backlight panels
- Ultrabooks, ultraportables, and notebooks
- 2-in-1, convertible, and detachable notebooks
- Full-size tablet computers
- LCD panels
- Ultra-thin form factor mobile platforms

## Efficiency

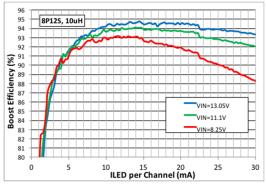


Figure 1. Typical Boost Efficiency - 8p12s

## Application

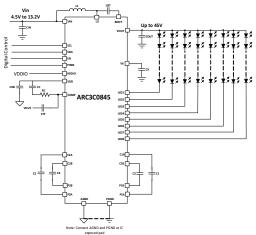


Figure 2. Typical Application Circuit

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# **Application Schematic**

Figure 3 shows the ARC3C0845/ARC3C0845W detailed application schematic. For compensation details, contact pSemi.

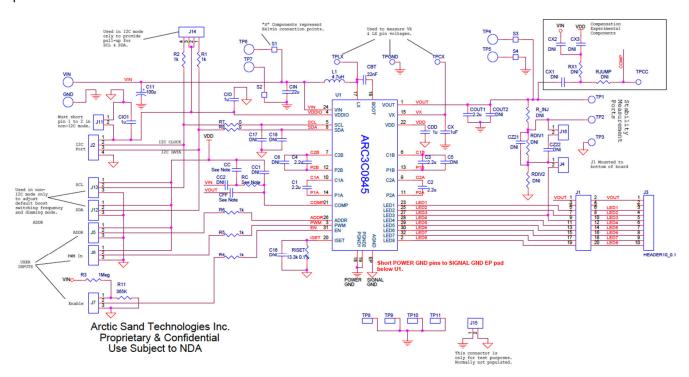


Figure 3. ARC3C0845/ARC3C0845W Detailed Application Schematic

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# **Application Circuit Part List**

Table 1 lists the recommended part numbers.

Table 1. Recommended Parts(1)

Component	Value	Part Size	Mfg. Part Number
CBT	22 nF 50V X7R	0402	GRM155R71H223KA12D
CX	1 μF 35V X5R	0402	GRM155R6YA105KE11
C3, C4	2.2 µF 50V X5R	1206	GJ8319R61H225KA12
C1, C2	2.2 µF 25V X5R	0805	C2012X5R1E225K085AC
CIN (2)	1.0 µF 16V X5R	0603	GRM188R61C105KA12D
CC (3)	-	0201	_
CFF (3)	-	0201	_
COUT	2.2 µF 50V X5R	1206	GJ8319R61H225KA12
CDD, CIO	1 µF 10V X5R	0402	GRM155R61A105KE15D
L1 <sup>(3)</sup>	4.7 µH	3.2 mm x 2.5 mm x 1.2 mm	DFE322512F-4R7M
RISET	13.3 kΩ	0402	Use tighter than 1% tolerance
RC <sup>(3)</sup>	-	0201	_

#### Notes:

- 1. Components in this part list are optimized for 8P12S or higher applications. For an optimized selection based on your application, contact pSemi.
- 2. Value might require an adjustment based on proximity of the input source to eliminate input voltage ringing.
- 3. For an optimized selection based on your application, contact pSemi.

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## **Ordering Information**

Table 2 lists the ARC3C0845/ARC3C0845W order codes and shipping methods.

Table 2. ARC3C0845/ARC3C0845W Order Codes and Shipping Methods

Order Codes	Description	Packaging	Shipping Method
ARC3C0845-R	High-Efficiency LED Backlight Driver	4 mm x 4 mm QFN, 32-pin	5000 units/large tape and reel
ARC3C0845-V			250 units/small tape and reel
ARC3C0845-G			10 units/sample waffle tray
ARC3C0845W-R	High-Efficiency LED Backlight Driver	3.44 mm x 2.415 mm WLCSP, 40-pin	5000 units/large tape and reel
ARC3C0845W-V			250 units/small tape and reel
ARC3C0845W-G			10 units/sample waffle tray

## **Document Categories**

#### Advance Information

The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

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#### **Product Specification**

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#### **Product Brief**

This document contains a shortened version of the datasheet. For the full datasheet, contact sales@psemi.com.

#### Sales Contact

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